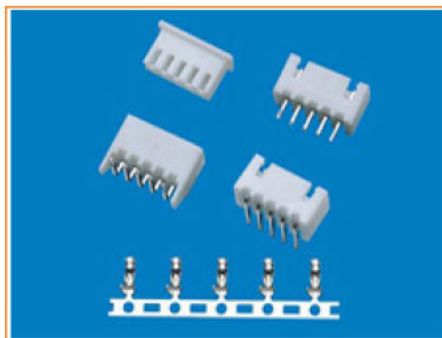
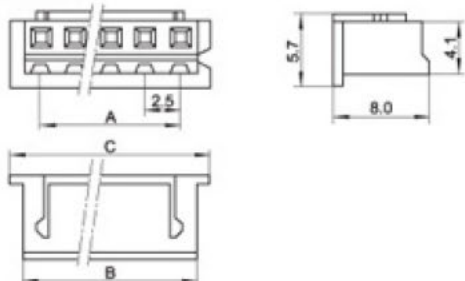


Housing



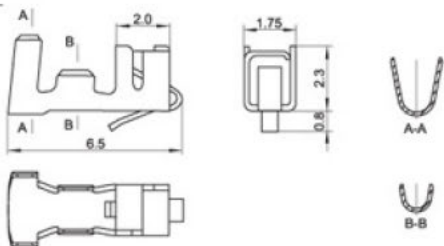
Housing

Wafer 180°

	A	B	C
2	2.5	5.7	7.5
3	5.0	8.2	10.0
4	7.5	10.7	12.5
5	10.0	13.2	15.0
6	12.5	15.7	17.5
7	15.0	18.2	20.0
8	17.5	20.7	22.5
9	20.0	23.2	25.0
10	22.5	25.7	27.5
11	25.0	28.2	30.0
12	27.5	30.7	32.5
13	30.0	33.2	35.0
14	32.5	35.7	37.5
15	35.0	38.2	40.0
16	37.5	40.7	42.5
17	40.0	43.2	45.0
18	42.5	45.7	47.5
19	45.0	48.2	50.0
20	47.5	50.7	52.5

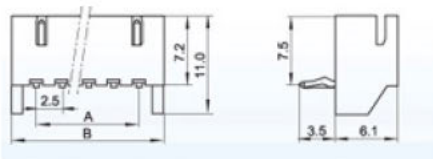
	A	B
2	2.5	7.6
3	5.0	10.1
4	7.5	12.6
5	10.0	15.1
6	12.5	17.6
7	15.0	20.1
8	17.5	22.6
9	20.0	25.1
10	22.5	27.6
11	25.0	30.1
12	27.5	32.6
13	30.0	35.1
14	32.5	37.6
15	35.0	40.1
16	37.5	42.6
17	40.0	45.1
18	42.5	47.6
19	45.0	50.1
20	47.5	52.6

Terminal



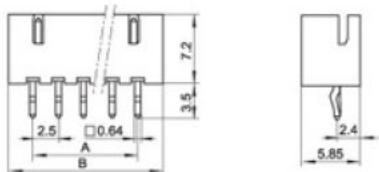
Nr. Poles: 2-20
 Wire Dia: AWG 28-22
 Oper. Temp: -25+85°C
 Rated Voltage: 250VAC
 Rated Current: 3A
 Contact Resistance: less 0,02Ohm
 Dielectric Resistance: 1000MOhm
 Tested Voltage: 1000VAC / 1min.

WR - Wafer 90°



XX: Number of Pole
 Y: W- Wafer 180°
 WR - Wafer 90°
 H - Housing
 T - Terminal

Wafer 180°



RoHS Compliant

SCHMID-M

APPD. David
 DWG. Braun
 DATE 2017/04

SCALE 5:1
 SIZE A4
 PAGE 1 OF 1

Toleration
 X ± 0.38
 XX ± 0.25
 XXX ± 0.10
 0° ± 2°

PART NO: SM C03 2615 XX Y
 TITLE: Wire to Board RM 2,50mm